

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

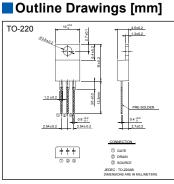
Super J-MOS series

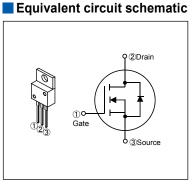
N-Channel enhancement mode power MOSFET

Features

Pb-free lead terminal **RoHS** compliant

Applications For switching





Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Veltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current		±15	А	Tc=25°C Note*1
Continuous Drain Current	lo	±9.5	А	Tc=100°C Note*1
Pulsed Drain Current	DP	±45	А	Note *1
Gate-Source Voltage	Vgs	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	3.7	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	506.5	mJ	Note *3
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/µs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	15	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
Maximum Power Discinction	Po	2.02	W	T₂=25°C
Maximum Power Dissipation		135	vv	Tc=25°C
Operating and Starage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	Tstg	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature. Note *2 : Tch≤150°C, See Fig.1 and Fig.2 Note *3 : Starting Tch=25°C, IAs=2.3A, L=176mH, VpD=60V, Rg=50Ω, See Fig.1 and Fig.2

EAs limited by maximum channel temperature and avalanche current. Note *4 : Ir≤-ID, -di/dt=100A/µs, VDs peak≤600V, Tch≤150°C.

Note *5 : IF≤-ID, dV/dt=15kV/µs, VDs peak≤600V, Tch≤150°C

Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I₀=250µA V₀s=V₀s		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	ldss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	lass	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I₀=7.5A V₀s=10V		-	0.195	0.23	Ω
Gate resistance	RG	f=1MHz, open drain		-	3.4	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =7.5A V _{DS} =25V	7.3	14.7	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	1050	-	
Output Capacitance	Coss	V _{GS} =0V	-	34	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	3.2	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V	-	77	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{GS} =0V V _{DS} =0480V ID=constant	-	256	-	
Turne On Time	t _{d(on)}		-	32	-	
Turn-On Time	tr	V₀₀=400V, V₀s=10V I₀=7.5A, R₀=24Ω See Fig.3 and Fig.4	-	13.5	-	ns
Turn Off Time	t _{d(off)}		-	124	-	
Turn-Off Time tr	tr		-	17.5	-	
Total Gate Charge	QG		-	43	-	nC
Gate-Source Charge	Q _{GS}	V _{DD} =480V, I _D =15A V _{GS} =10V See Fig.5	-	11.5	-	
Gate-Drain Charge	Q _{GD}		-	13.5	-	
Drain-Source crossover Charge	Qsw		-	7	-	1

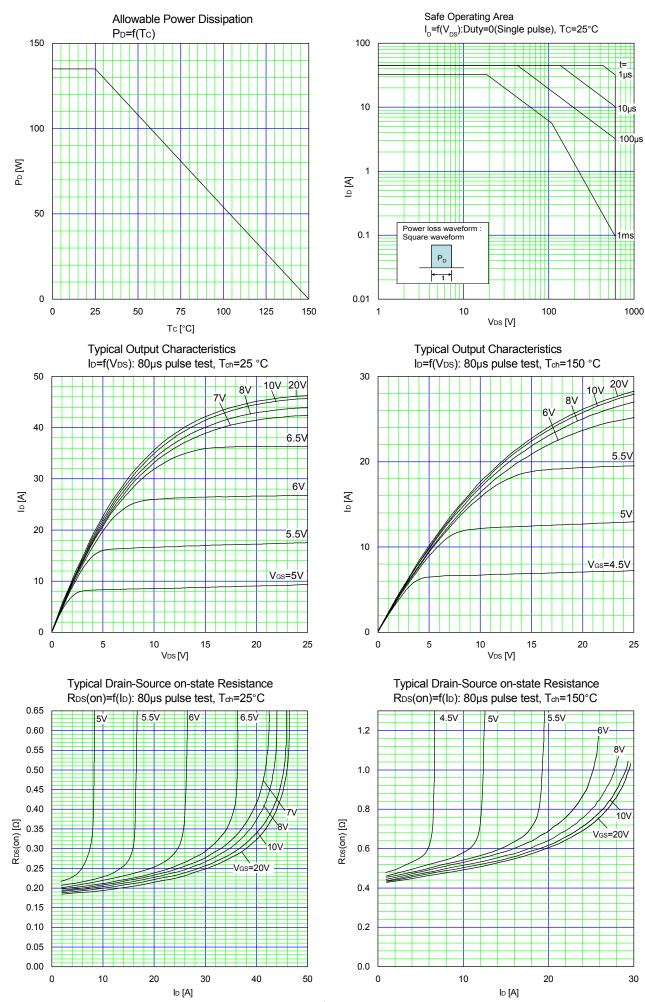
Note *6 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{Ds} is rising from 0 to 80% BV_{Dss}. Note *7 : $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{Ds} is rising from 0 to 80% BV_{Dss}.

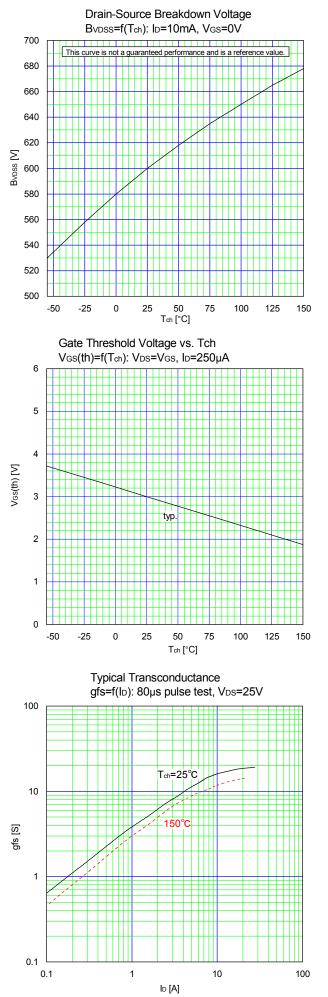
Reverse Diode

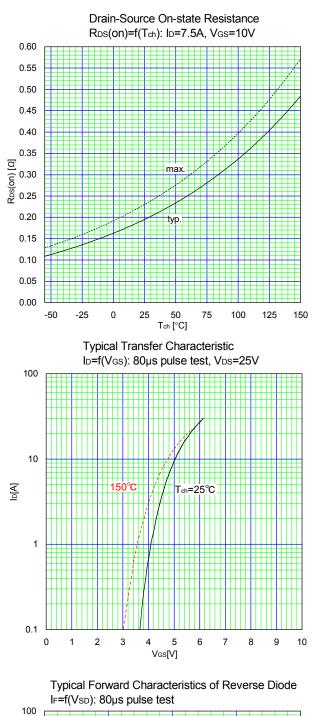
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=42.2mH, T₀ =25°C See Fig.1 and Fig.2	3.7	-	-	А
Diode Forward On-Voltage	V _{SD}	I⊧=15A, V _{GS} =0V T _{ch} =25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	- I⊧=15A, V₀₀=400V -di/dt=100A/μs T₀+=25°C See Fig.6 and Fig.7		345	-	ns
Reverse Recovery Charge	Qrr		-	5	-	μC
Peak Reverse Recovery Current	Ігр		-	29	-	А

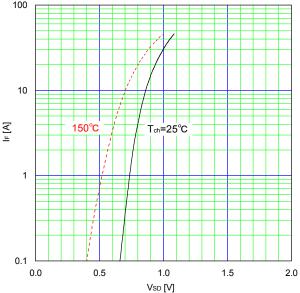
Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.93	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	62	°C/W



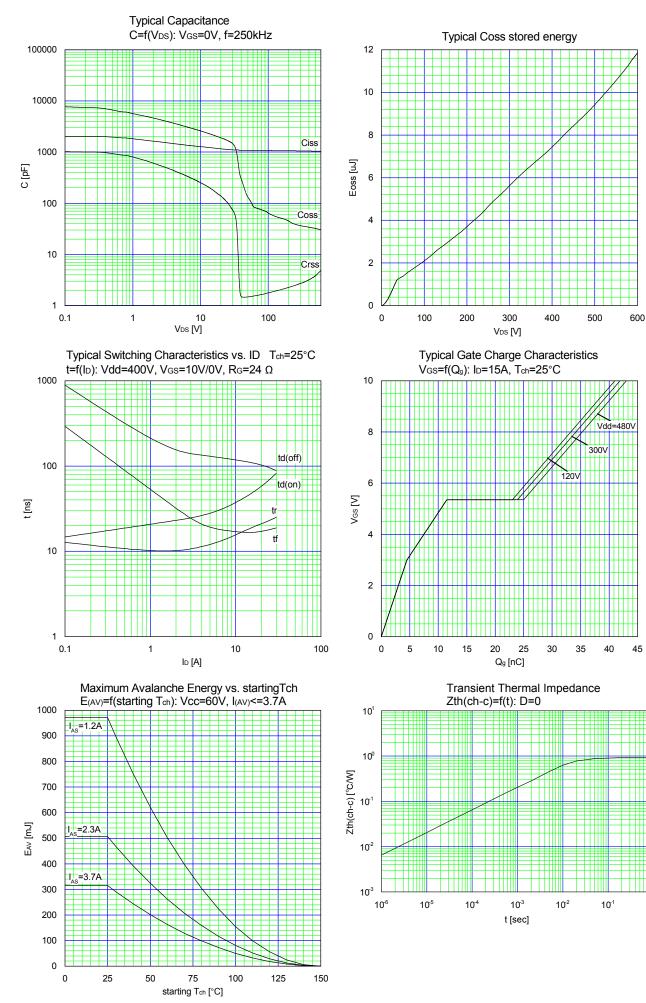


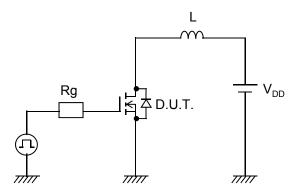




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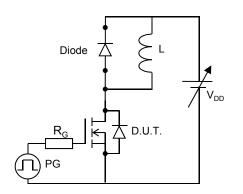


Fig.3 Switching Test circuit

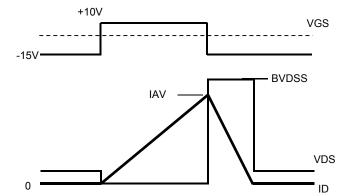


Fig.2 Operating waveforms of Avalanche Test

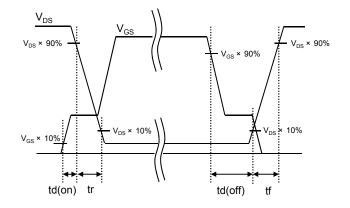


Fig.4 Operating waveform of Switching Test

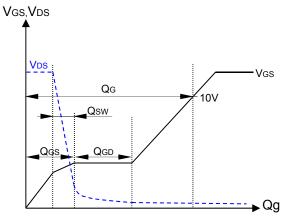
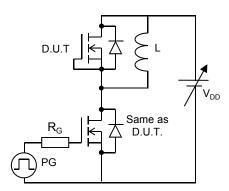


Fig.5 Operating waveform of Gate charge Test



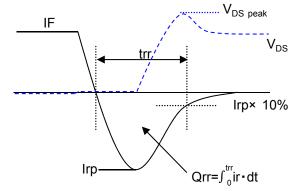


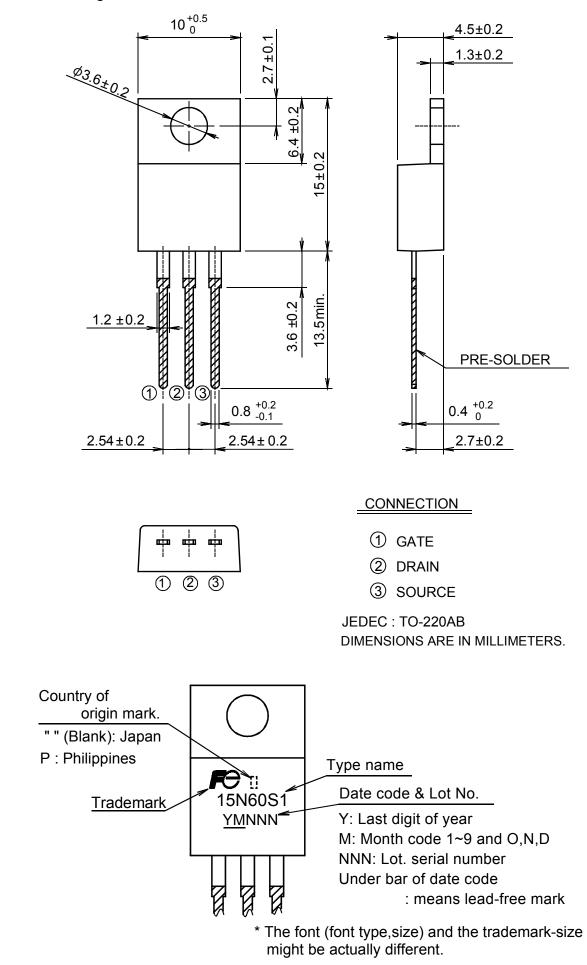
Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

Marking

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Outview: TO-220 Package



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